

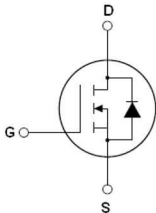
# N-Channel Super Junction Power MOSFET III

## General Description

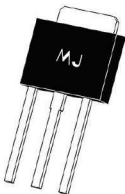
The series of devices use advanced super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

## Features

- ◆ New technology for high voltage device
- ◆ Low on-resistance and low conduction losses
- ◆ Small package
- ◆ Ultra Low Gate Charge cause lower driving requirements
- ◆ 100% Avalanche Tested
- ◆ ROHS compliant



Schematic diagram



TO-251

## Application

- ◆ Power factor correction (PFC)
- ◆ Switched mode power supplies(SMPS)
- ◆ Uninterruptible Power Supply (UPS)

|                 |      |            |
|-----------------|------|------------|
| $V_{DS}$        | 700  | V          |
| $R_{DS(ON)TYP}$ | 1100 | m $\Omega$ |
| $I_D$           | 4    | A          |

## Package Marking And Ordering Information

| Device    | Device Package | Marking   |
|-----------|----------------|-----------|
| MJ70T1K2I | TO-251         | MJ70T1K2I |

Table 1. Absolute Maximum Ratings (Tc=25℃)

| Parameter   | Symbol           | Value    | Unit |
|---|------------------|----------|------|
| Drain-Source Voltage ( $V_{GS}=0V$ )  | $V_{DS}$         | 700      | V    |
| Gate-Source Voltage ( $V_{DS}=0V$ ) ,AC ( $f>1\text{ Hz}$ )                     | $V_{GS}$         | $\pm 30$ | V    |
| Continuous Drain Current at $T_c=25^{\circ}C$                                   | $I_D$ (DC)       | 4        | A    |
| Continuous Drain Current at $T_c=100^{\circ}C$                                  | $I_D$ (DC)       | 2.5      | A    |
| Pulsed drain current <sup>(Note 1)</sup>  | $I_{DM}$ (pluse) | 16       | A    |
| Maximum Power Dissipation ( $T_c=25^{\circ}C$ )                                 | $P_D$            | 41       | W    |
| Derate above 25℃  | $P_D$            | 0.328    | W/℃  |
| Single pulse avalanche energy <sup>(Note 2)</sup>                               | $E_{AS}$         | 27       | mJ   |
| Avalanche current <sup>(Note 1)</sup>   | $I_{AR}$         | 0.7      | A    |
| Repetitive Avalanche energy, $t_{AR}$ limited by $T_{jmax}$ <sup>(Note 1)</sup> | $E_{AR}$         | 0.1      | mJ   |

| Parameter   | Symbol         | Value      | Unit |
|---|----------------|------------|------|
| Drain Source voltage slope, $V_{DS} \leq 480\text{ V}$              | $dv/dt$        | 50         | V/ns |
| Reverse diode $dv/dt$ , $V_{DS} \leq 480\text{ V}$ , $I_{SD} < I_D$ | $dv/dt$        | 15         | V/ns |
| Operating Junction and Storage Temperature Range                    | $T_J, T_{STG}$ | -55...+150 | ℃    |

\* limited by maximum junction temperature

Table 2. Thermal Characteristic

| Parameter   | Symbol            | Value | Unit |
|---|-------------------|-------|------|
| Thermal Resistance, Junction-to-Case (Maximum)    | R <sub>thJC</sub> | 3.0   | °C/W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R <sub>thJA</sub> | 62    | °C/W |

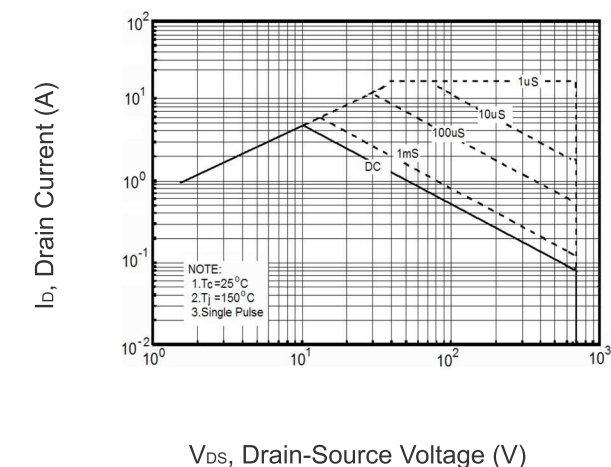
Table 3. Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

| Parameter                                  | Symbol              | Condition   | Min | Typ  | Max  | Unit |
|--|---------------------|---|-----|------|------|------|
| On/off states                              |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA   | 700 | -    | -    | V    |
| Zero Gate Voltage Drain Current (Tc=25°C)  | I <sub>DSS</sub>    | V <sub>DS</sub> =700V,V <sub>GS</sub> =0V   | -   | -    | 1    | μA   |
| Zero Gate Voltage Drain Current (Tc=125°C) | I <sub>DSS</sub>    | V <sub>DS</sub> =700V,V <sub>GS</sub> =0V   | -   | -    | 50   | μA   |
| Gate-Body Leakage Current                  | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V   | -   | -    | ±100 | nA   |
| Gate Threshold Voltage                     | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA                               | 3   | -    | 4    | V    |
| Drain-Source On-State Resistance           | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V,I <sub>D</sub> =2A   | -   | 1100 | 1300 | mΩ   |
| Dynamic Characteristics                    |                     |   |     |      |      |      |
| Input Capacitance                          | C <sub>ies</sub>    | V <sub>DS</sub> =50V,V <sub>GS</sub> =0V<br>F=1.0MHz                                  | -   | 304  | -    | PF   |
| Output Capacitance                         | C <sub>OSS</sub>    |   | -   | 17   | -    | PF   |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    |   | -   | 0.5  | -    | PF   |
| Total Gate Charge                          | Q <sub>g</sub>      | V <sub>DS</sub> =480V,I <sub>D</sub> =4A<br>V <sub>GS</sub> =10V                      | -   | 8.8  | 12   | nC   |
| Gate-Source Charge                         | Q <sub>gs</sub>     |   | -   | 2.3  | -    | nC   |
| Gate-Drain Charge                          | Q <sub>gd</sub>     |   | -   | 4    | -    | nC   |
| Switching times                            |                     |   |     |      |      |      |
| Turn-on Delay Time                         | t <sub>d(on)</sub>  | V <sub>DD</sub> =380V,I <sub>D</sub> =2.5A<br>R <sub>G</sub> =5Ω,V <sub>GS</sub> =10V | -   | 8    | -    | nS   |
| Turn-on Rise Time                          | t <sub>r</sub>      |   | -   | 4    | -    | nS   |
| Turn-Off Delay Time                        | t <sub>d(off)</sub> |   | -   | 52   | 70   | nS   |
| Turn-Off Fall Time                         | t <sub>f</sub>      |   | -   | 9    | 18   | nS   |
| Source- Drain Diode Characteristics        |                     |   |     |      |      |      |
| Source-drain current (Body Diode)          | I <sub>SD</sub>     | T <sub>C</sub> =25°C  | -   | -    | 4    | A    |
| Pulsed Source-drain current (Body Diode)   | I <sub>SDM</sub>    |   | -   | -    | 16   | A    |
| Forward On Voltage                         | V <sub>SD</sub>     | T <sub>J</sub> =25°C,I <sub>SD</sub> =4A,V <sub>GS</sub> =0V                          | -   | 0.9  | 1.2  | V    |
| Reverse Recovery Time                      | t <sub>rr</sub>     | T <sub>J</sub> =25°C,I <sub>F</sub> =2A<br>di/dt=100A/μs                              | -   | 200  | -    | nS   |
| Reverse Recovery Charge                    | Q <sub>rr</sub>     |   | -   | 0.6  | -    | uC   |
| Peak reverse recovery current              | I <sub>rrm</sub>    |   | -   | 6    | -    | A    |

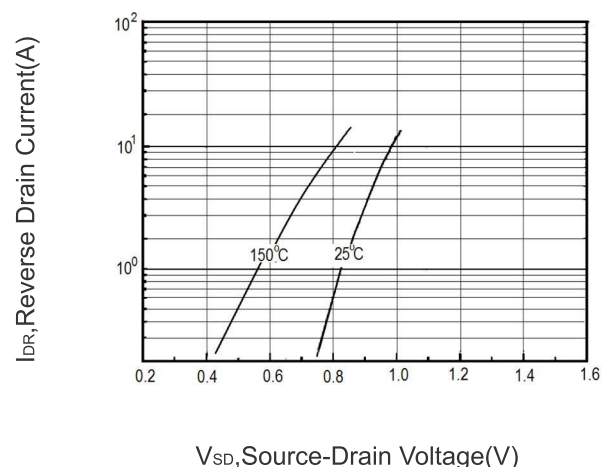
## Notes

- 1.Repetitive Rating: Pulse width limited by maximum junction temperature
2. $T_J=25^{\circ}\text{C}$ ,  $V_{DD}=50\text{V}$ ,  $V_G=10\text{V}$ ,  $R_G=25\Omega$

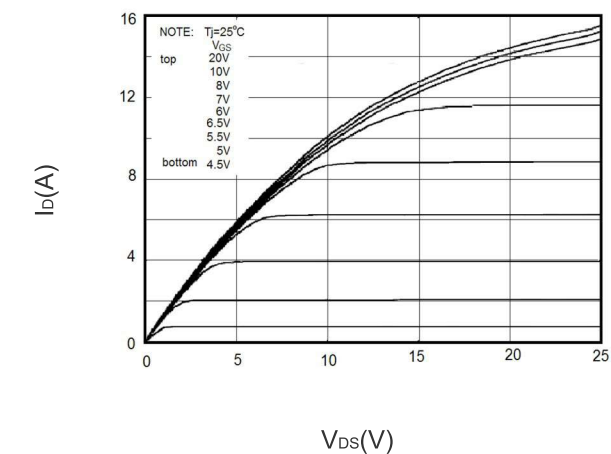
## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)



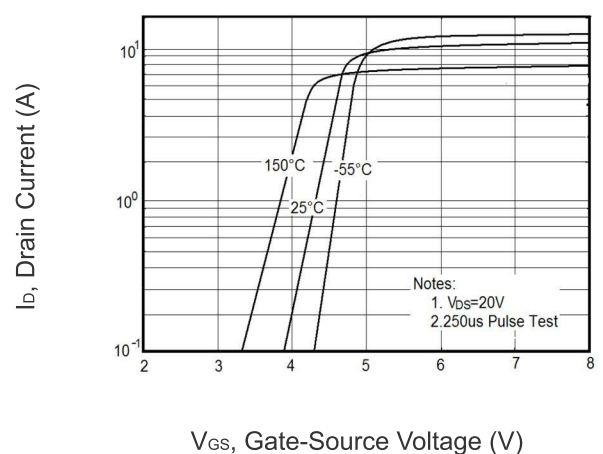
$V_{DS}$ , Drain-Source Voltage (V)  
Figure 1 Safe operating area



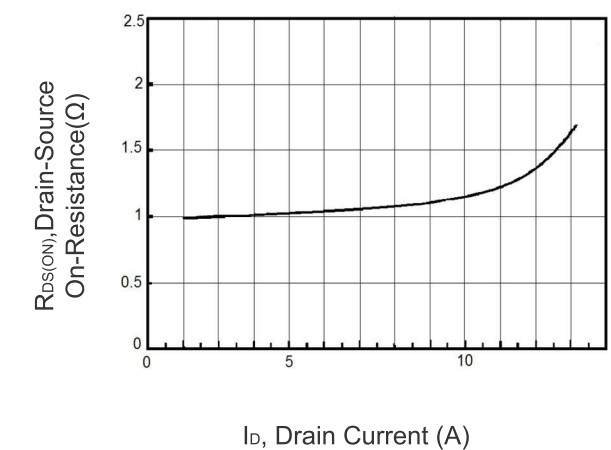
$V_{SD}$ , Source-Drain Voltage(V)  
Figure 2 Source-Drain Diode Forward Voltage



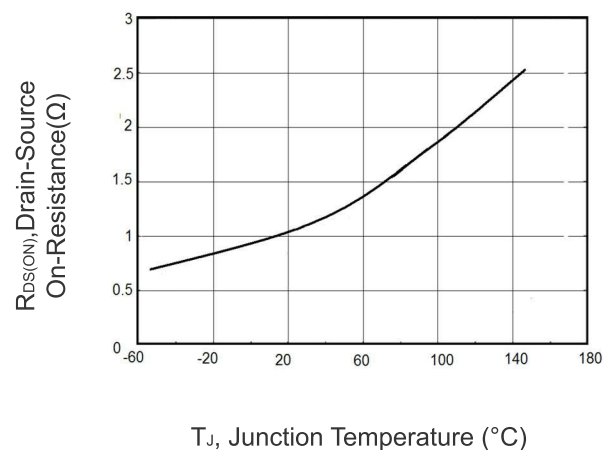
$V_{DS}(V)$   
Figure 3 Output characteristics



$V_{GS}$ , Gate-Source Voltage (V)  
Figure 4 Transfer characteristics



$I_D$ , Drain Current (A)  
Figure 5 Static drain-source on resistance



$T_J$ , Junction Temperature ( $^{\circ}\text{C}$ )  
Figure 6  $R_{DS(ON)}$  vs Junction Temperature

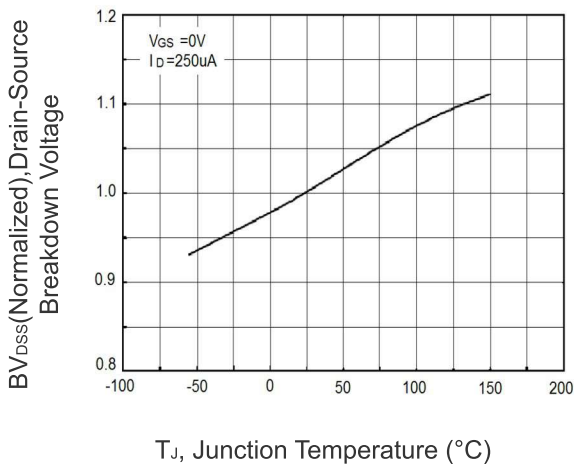


Figure 7  $BV_{DSS}$  vs Junction Temperature

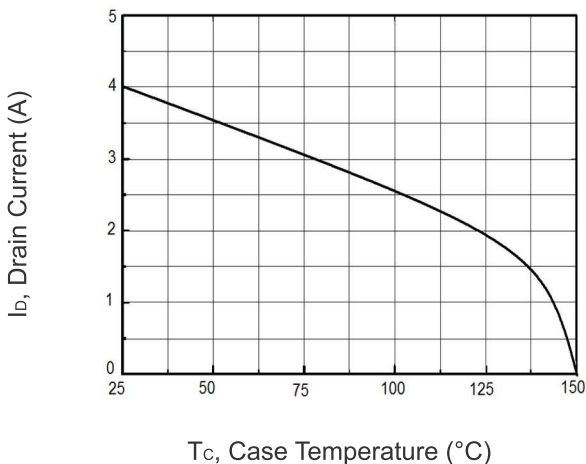


Figure 8 Maximum  $I_D$  vs Junction Temperature

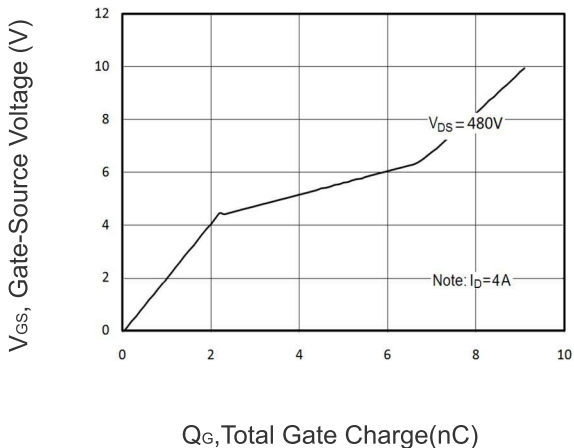


Figure 9 Gate charge waveforms

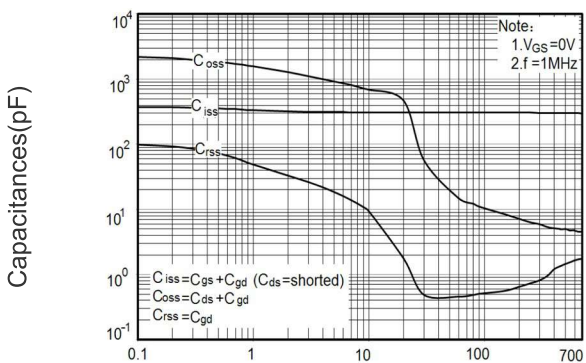


Figure 10 Capacitance

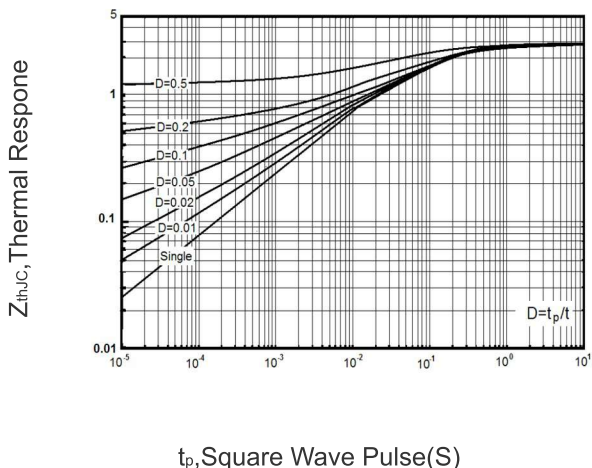
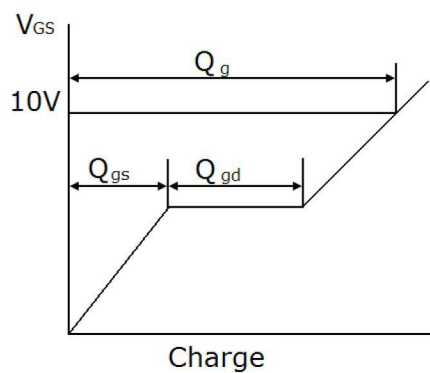
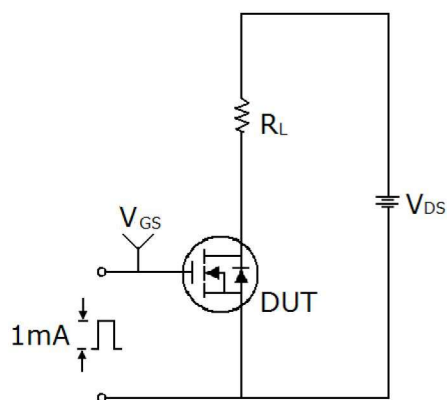
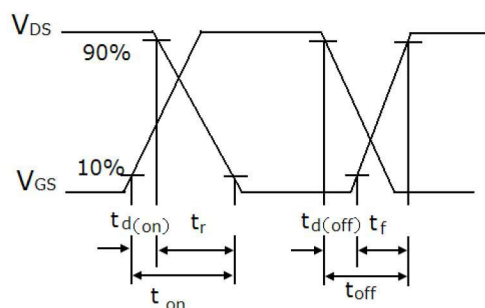
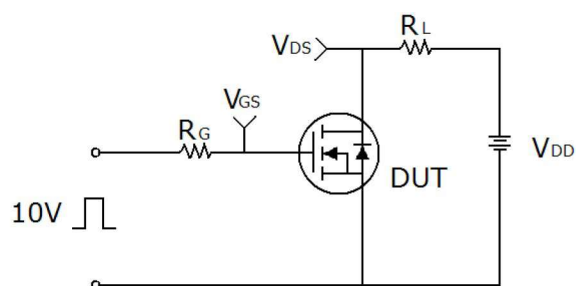


Figure 11 Transient Thermal Impedance

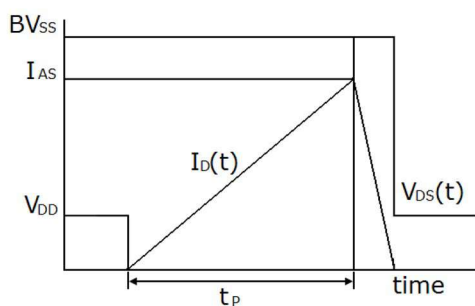
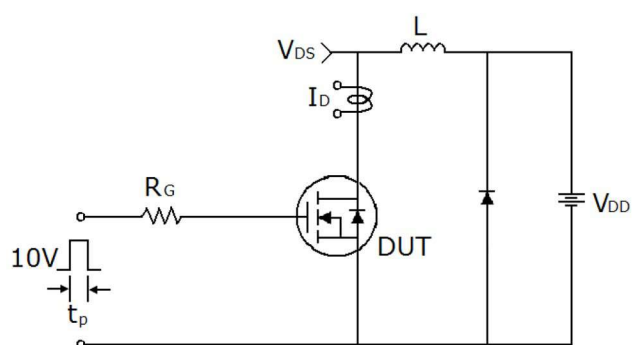
## Test circuit



Gate charge test circuit & Waveform

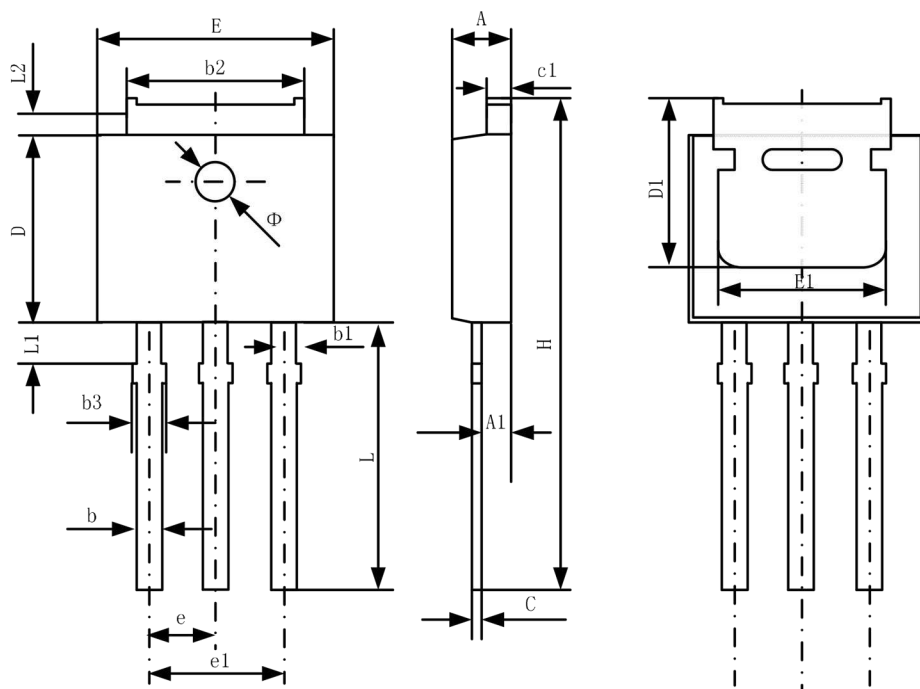


Switch Time Test Circuit



Unclamped Inductive Switching Test Circuit & Waveforms

## TO-251 Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 2.20                      | 2.35  | 0.087                | 0.093 |
| A1     | 0.90                      | 1.10  | 0.035                | 0.043 |
| b      | 0.56                      | 0.69  | 0.022                | 0.027 |
| b1     | 0.77                      | 0.90  | 0.030                | 0.035 |
| b2     | 5.23                      | 5.43  | 0.206                | 0.214 |
| b3     |                           | 1.05  | 0.000                | 0.041 |
| C      | 0.46                      | 0.59  | 0.018                | 0.023 |
| c1     | 0.46                      | 0.59  | 0.018                | 0.023 |
| D      | 6.00                      | 6.20  | 0.236                | 0.244 |
| D1     | 5.20                      |       | 0.205                |       |
| E      | 6.50                      | 6.70  | 0.256                | 0.264 |
| E1     | 4.60                      | 5.00  | 0.181                |       |
| e      | 2.24                      | 2.34  | 0.088                | 0.092 |
| e1     | 4.47                      | 4.67  | 0.176                | 0.184 |
| H      | 16.18                     | 16.78 | 0.637                | 0.661 |
| L      | 9.00                      | 9.60  | 0.354                | 0.378 |
| L1     | 0.95                      | 1.35  | 0.037                | 0.053 |
| L2     | 0.90                      | 1.25  | 0.035                | 0.049 |

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